

General Description

The KSE10N03 is the high cell density trenched N-ch MOSFET, which provides excellent RDSON and efficiency for most of the small power switching and load switch applications.

The KSE10N03 meet the RoHS and Green Product requirement with full function reliability approved.

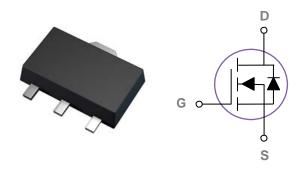
Product Summary

V _{DS} (V)	$R_{DS(On)}$ (m Ω)	I _D (A)
100	106 at V _{GS} = 10 V	3.0
	115 atV _{GS} = 4.5 V	2.5

Features

- Super Low Gate Charge
- Excellent Cdv/dt effect decline
- Excellent package for good heat dissipation

SOT89 Pin Configuration



Applications

- Power switching application
- industrial power supplies
- LED backlighting

100% UIS TESTED! 100% ΔVds TESTED!

Absolute Maximum Ratings Tc=25℃ unless otherwise noted

Symbol	Parameter	Rating	Units
V _{DS}	Drain-Source Voltage	100	V
V _{GS}	Gate-Source Voltage	±20	V
	Drain Current – Continuous (Tc=25°C)	3.0	Α
lD	Drain Current − Continuous (T _C =100°C)	1.4	А
DM	Drain Current – Pulsed¹	15	Α
`	Power Dissipation (Tc=25°C)	2.4	W
O _D	Power Dissipation – Derate above 25℃	0.3	W/°C
T _{STG}	Storage Temperature Range	-55 to 150	°C
Гл	Operating Junction Temperature Range	-55 to 150	$^{\circ}$

Thermal Characteristics

Symbol	Parameter	Тур.	Max.	Unit
$R_{\theta JA}$	Thermal Resistance Junction to ambient		61	°C/W
Rejc	Thermal Resistance Junction to Case		3.2	°C/W



Electrical Characteristics (T_J=25 °C, unless otherwise noted) Off Characteristics

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit
BV _{DSS}	Drain-Source Breakdown Voltage	V _{GS} =0V , I _D =250uA	100			V
$\triangle BV_{DSS}/\triangle T_{J}$	BV _{DSS} Temperature Coefficient	Reference to 25℃ , I _D =1mA		0.01		V/°C
I _{DSS}	Drain Source Leakage Current	V _{DS} =50V , V _{GS} =0V , T _J =25℃			1	uA
	Drain-Source Leakage Current	V _{DS} =50V , V _{GS} =0V , T _J =125℃			10	uA
I _{GSS}	Gate-Source Leakage Current	V_{GS} = $\pm 20 V$, V_{DS} = $0 V$			±100	nA

On Characteristics

D	Static Drain-Source On-Resistance	V _{GS} =10V , I _D =3.0A		106	134	mΩ
R _{DS(ON)}		V _{GS} =4.5V , I _D =1.5A		115	142	mΩ
V _{GS(th)}	Gate Threshold Voltage	V _{GS} =V _{DS} , I _D =250uA	1.0	1.68	2.7	V
$\triangle V_{GS(th)}$	V _{GS(th)} Temperature Coefficient			1.6		mV/℃
gfs	Forward Transconductance	V _{DS} =10V , I _S =2A		16		S

Dynamic and switching Characteristics

Q_g	Total Gate Charge ^{2,3}		 8.7	15	
Q_gs	Gate-Source Charge ^{2,3}	V_{DS} =50V , V_{GS} =10V , I_{D} =2A	 1.4	3.0	nC
Q_gd	Gate-Drain Charge ^{2, 3}		 2.4	4.0	
$T_{d(on)}$	Turn-On Delay Time ^{2, 3}		 7.6	13	
Tr	Rise Time ^{2, 3}	V_{DS} =50V , V_{GS} =10V , R_{G} =3.3	 3.3	6	no
$T_{d(off)}$	Turn-Off Delay Time ^{2, 3}	Ω I _D =1A	 28	37	ns
T _f	Fall Time ^{2,3}		 6.2	9	
C _{iss}	Input Capacitance		 850	1057	
C_{oss}	Output Capacitance	V_{DS} =15V , V_{GS} =0V , F=1MHz	 56	75	pF
C _{rss}	Reverse Transfer Capacitance		 30	50	

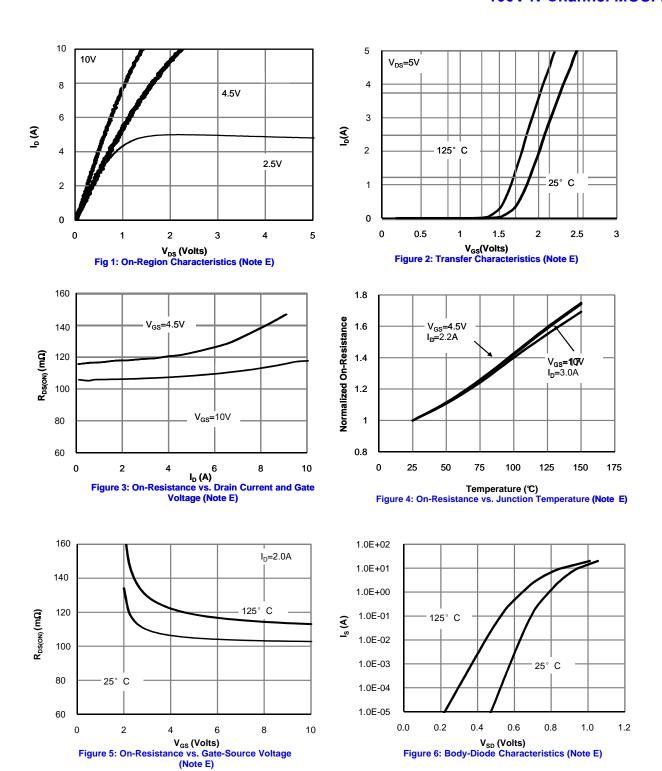
Drain-Source Diode Characteristics and Maximum Ratings

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit
ls	Continuous Source Current	V _G =V _D =0V , Force Current			3.0	Α
lsм	Pulsed Source Current				15	Α
V _{SD}	Diode Forward Voltage	V _{GS} =0V , I _S =1A , T _J =25℃			1.2	V

Note:

- 1. Repetitive Rating: Pulsed width limited by maximum junction temperature.
- 2. The data tested by pulsed , pulse width \leq 300us , duty cycle \leq 2%.
- Essentially independent of operating temperature.





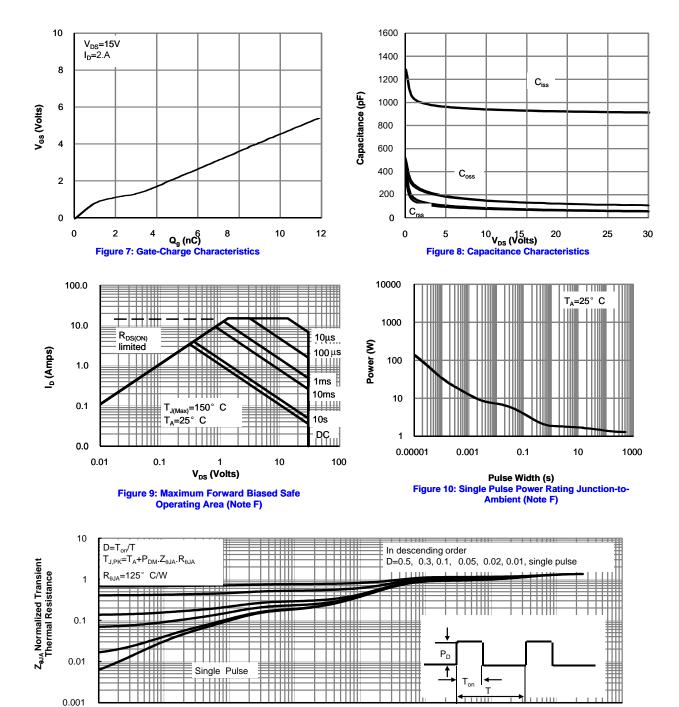


0.00001

0.0001

0.001

100V N-Channel MOSFET



Pulse Width (s)
Figure 11: Normalized Maximum Transient Thermal Impedance (Note F)

0.1

10

100

1000

0.01



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